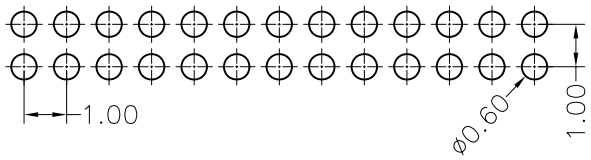
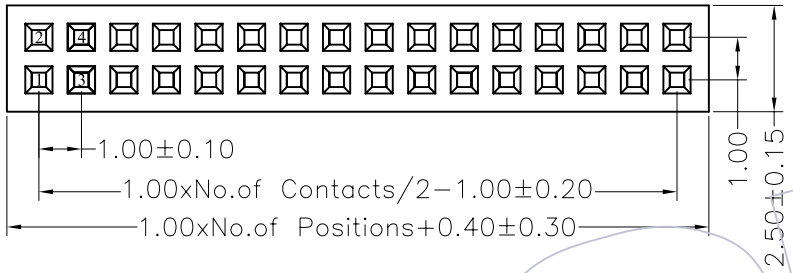
HSF

NOTES:
Current Rating: 1.0AMP
Contact Resistance: 20mΩ Max
Withstand Voltage: 500V AC/DC
Insulation Resistance: 1000MΩ Min
Operation Temperature: −40℃ to +105℃

Contact Material:Phosphor Bronze
Contact plating:Au or Sn over Ni
Insulator Material:PA6T+30%GF UL94V−0

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)





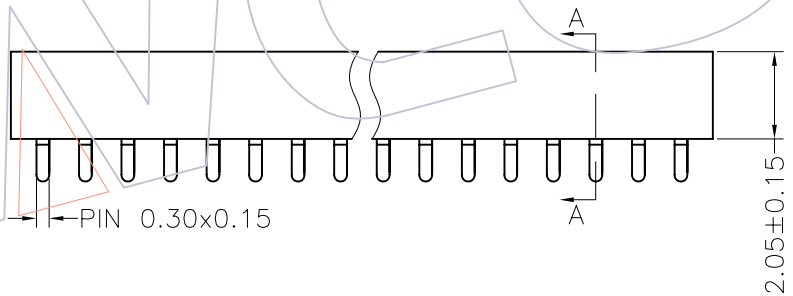
Ordering Information

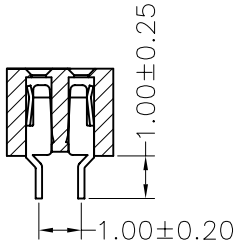
2521-2 XX S XX CUN X 1

No.of Pins per Row: 02~50Pin

Contact Plating:
G0=Gold Flash
G1=3u"Gold
G2=5u"Gold
G3=10u"Gold
G4=15u"Gold
G5=30u"Gold
S0=Gold Flash/Tin
S1=3u"Gold/Tin
S2=5u"Gold/Tin
S3=10u"Gold/Tin
S4=15u"Gold/Tin
S5=30u"Gold/Tin
SN=Tin

Packing:
T=Tube
T=Tube+CAP
R=Tape&Reel+CAP





SECTION A−A

WCON

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE
A0	08/09/23	NEW	———	———

OPERATION				
X.X	±0.40	DRAW	WEIXD	08.09.23
X.XX	±0.25	DESIGN		
X.XXX	±0.15	CHECK		
Angle	± 3°	APPROVE		
DIM	TOL			

SCALE	6:1
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

WCON 维峰五金电子有限公司
WAFE HARDWARE ELECTRONICS CO.LTD

PART NO.	2521-2XXSXXCUNX1
TITLE:	FH1.00 DUAL ROW 180° H=2.10
Customer NO.	